Development of a conduction-cooled SRF cavity for industrial accelerators

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Motivation

- The conceptual design and cost analysis for a 750 MHz, CW, 1 MeV, 1 MW SRF electron Linac for environmental remediation was published in 2018
 - Nb₃Sn/Nb/Cu, low- β , SRF elliptical cavity cooled by conduction with 4 cryocoolers



- RF power is a major capital and operating cost \implies change frequency to 915 MHz, matching that of low-cost, commercial, high-power magnetrons for industrial heating
- Need an experimental proof-of-concept of an SRF cavity cooled by conduction by multiple cryocoolers in a horizontal cryostat

G. Ciovati et al., Design of a cw, low energy, high power superconducting linac for environmental applications, Phys. Rev. Accel. Beams 21, 091601 (2018)



Prototype cavity to demonstrate performance with conduction cooling

- We used a 952.6 MHz Nb single-cell cavity developed as a prototype for JLEIC
- The cavity reached 184 mT (E_{acc} = 46 MV/m) in LHe at 2 K after electropolishing and baking at 120 °C/12 h [Frank Marhauser]

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 $B_{p} (mT)$ $10^{11} \underbrace{0}_{12} \underbrace{24}_{36} \underbrace{48}_{60} \underbrace{0}_{13} \underbrace{13}_{13} \underbrace{12}_{14} \underbrace{13}_{15} \underbrace{12}_{14} \underbrace{13}_{15} \underbrace{12}_{14} \underbrace$

- Creep while under vacuum for extended period of time lead to damage of the Nb₃Sn film
- 2nd coating with additional crucibles with Sn/SnCl₂ for a more uniform coating
- Cavity performance limited by Multipacting at ~52 mT



Second step: thick Cu outer layer





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CTC Concurrent Technologies Corporation





Copper outer layer

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Copper outer layer

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4



CTC Concurrent Technologies Corporation









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4



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952.6 MHz Nb₃Sn/Nb/Cu cavity RF performance in LHe

 The cavity was degreased and HPRed



 The cavity was assembled with right-angle valve and burst disk, evacuated and tested in vertical cryostat with LHe at 4.3 K





952.6 MHz Nb₃Sn/Nb/Cu cavity RF performance in LHe

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 The cavity performance was limited by multipacting at 53 mT and was shipped under static vacuum to General Atomics for assembly into the horizontal test cryostat





Thermal Link Assembly

- A Cu thermal link was developed to:
 - Have sufficient flexibility to account for misalignments between cavity and cryocoolers' cold stage and thermal contraction
 - Have a thermal conductance of 17.5 W/K at 4 K and 39.7 W/K at 10 K, as determined by the thermal analysis of the 915 MHz cavity



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- The performance of one thermal link was measured with a cryocooler. The thermal conductance was 23 W/K at 4 K and 77 W/K at 10 K







Horizontal Test Cryostat

- A horizontal test cryostat was designed and procured to test the 952.6 MHz Nb₃Sn/Nb/Cu cavity, cooled by 3 GM-type cryocoolers (*RDE418-D4, Sumitomo*)
- The cavity is suspended by 4 nitronic rods on each side





Thermal shield



Inner magnetic shield





"SRF Laboratory" at General Atomics



- ~50 m² laboratory space at GA's flagship building in San Diego, CA
- Thick concrete-walls room with 5 x-ray area monitors
- Instrumentation and RF rack
- LLRF and data acquisition rack
- 3 He compressors









Horizontal test cryostat assembly

• Cavity is instrumented with 8 Cernox, 3 flux-gate magnetometers







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- Local magnetic field at 300 K < 0.5 μT
- Total static heat load on cold stages ~ 1 W



- Local magnetic field at 300 K < 0.5 μ T
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• Local magnetic field at 300 K < 0.5 μ T









 Local magnetic field at the cavity equator increased linearly with increasing cavity dissipated power → thermoelectric currents



 The total thermal conductance across the interfaces between the cavity and TLA and between the TLA and cryocooler's cold stage was ~4 W/K at 4 K



Microphonics measurements

- Frequency shift due to microphonics were measured at low rf field. The peak excursion was 23 Hz.
- A tri-axial accelerometer was placed at different locations of the HTC.
- The spectra show peaks at 1.2 Hz (frequency of the displacer inside the cryocooler) and ~40 Hz, ~120 Hz and ~360 Hz (He compressors)



Analysis of field dependence of surface resistance

- ANSYS simulations with the measured thermal conductance resulted in a maximum cavity dissipated power and temperature consisted with the measurements
- A simple 1D thermal feedback model provides a good description of $R_s(B_p)$ measured in LHe before and after Cu layer deposition and for the test with cryocoolers with the following:





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 B_{n} (mT)

40

- The increase of Q-slope after Cu layer deposition is due to increase of δ by a factor of ~7
 - This can be due to additional strain in the Nb₃Sn film because of differential thermal contraction between the Nb and the Cu



50

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- The cavity cooled by 3 cryocoolers in a horizontal test cryostat achieved B_p =50 mT (E_{acc} = 12.4 MV/m), the highest achieved in a conduction-cooled cavity to date

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 - increased the mechanical and thermal stability of the cavity
 - residual magnetic fields due to thermocurrents
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- Conceptual design for 10 MeV, 1 MW, CW linac is being developed (Poster TUPTB033)



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Development of a prototype superconducting radio-frequency cavity for conduction-cooled accelerators

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Accelerator R&D and Production (ARDAP)

